

2SJ484

Silicon P-Channel MOS FET
High Speed Power Switching

HITACHI

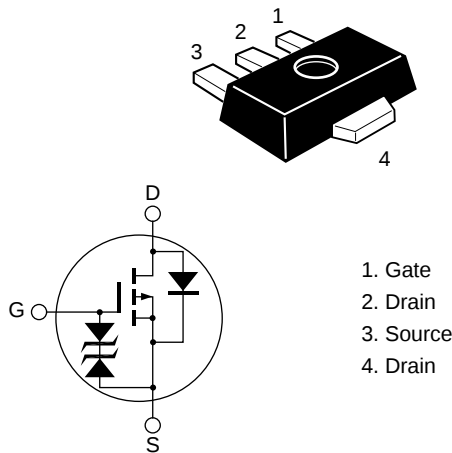
ADE-208-501 A
2nd. Edition

Features

- Low on-resistance
 $R_{DS(on)} = 0.18 \Omega$ typ. (at $V_{GS} = -10V$, $I_D = -1A$)
- Low drive current
- High speed switching
- 4V gate drive devices.

Outline

UPAK



Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	−30	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	−2	A
Drain peak current	I _{D(pulse)} ^{*1}	−4	A
Body to drain diode reverse drain current	I _{DR}	−2	A
Channel dissipation	Pch ^{*2}	1	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	−55 to +150	°C

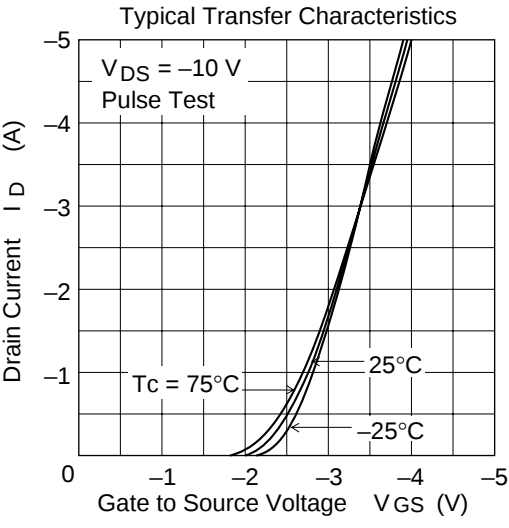
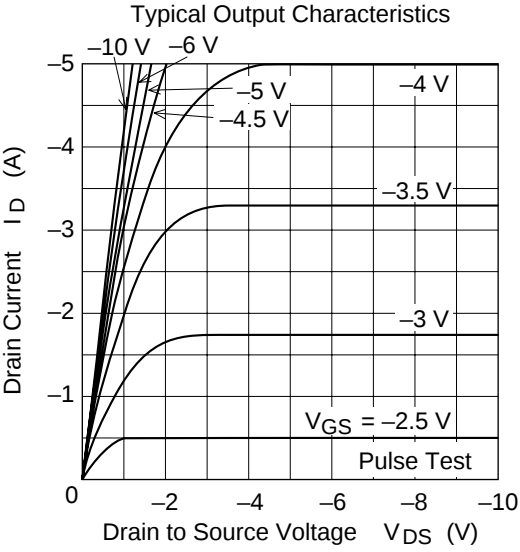
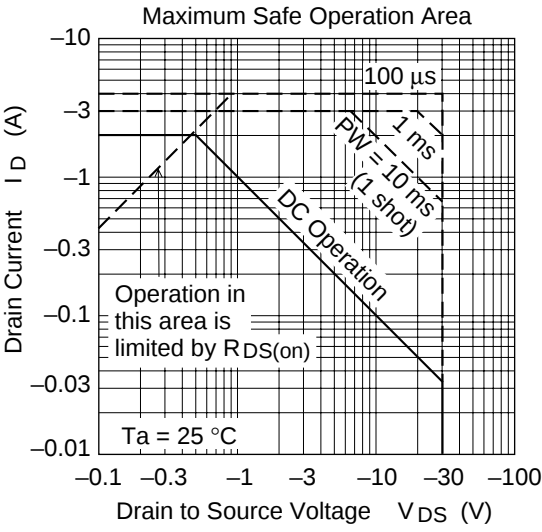
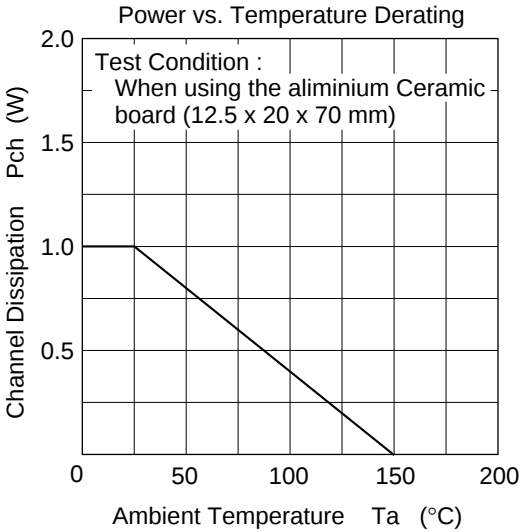
Notes: 1. PW ≤ 100μs, duty cycle ≤ 10 %
2. When using aluminium ceramic board (12.5 x 20 x 0.7 mm)

Electrical Characteristics (Ta = 25°C)

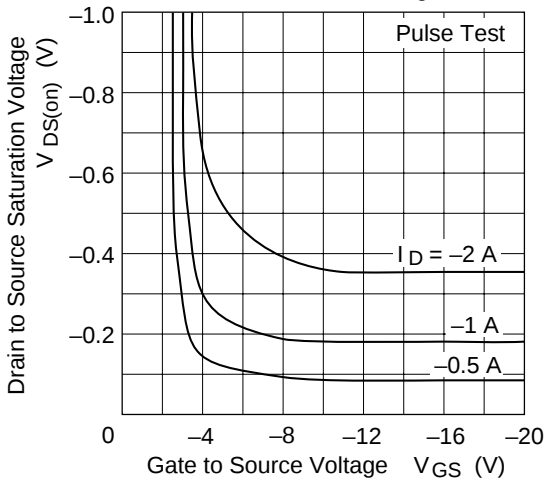
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	-30	—	—	V	$I_D = -10\text{mA}$, $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	± 20	—	—	V	$I_G = \pm 100\mu\text{A}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	-10	μA	$V_{DS} = -30\text{V}$, $V_{GS} = 0$
Gate to source leak current	I_{GSS}	—	—	± 10	μA	$V_{GS} = \pm 16\text{V}$, $V_{DS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	-1.0	—	-2.0	V	$I_D = -1\text{mA}$, $V_{DS} = -10\text{V}$
Static drain to source on state resistance	$R_{DS(on)}$	—	0.18	0.23	Ω	$I_D = -1\text{A}$, $V_{GS} = -10\text{V}^{*1}$
	$R_{DS(on)}$	—	0.3	0.45	Ω	$I_D = -1\text{A}$, $V_{GS} = -4\text{V}^{*1}$
Forward transfer admittance	$ y_{fs} $	1.2	2.0	—	S	$I_D = -1\text{A}$, $V_{DS} = -10\text{V}^{*1}$
Input capacitance	C_{iss}	—	230	—	pF	$V_{DS} = -10\text{V}$
Output capacitance	C_{oss}	—	140	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	C_{rss}	—	50	—	pF	$f = 1\text{MHz}$
Turn-on delay time	$t_{d(on)}$	—	10	—	ns	$I_D = -1\text{A}$, $R_L = 30\Omega$
Rise time	t_r	—	30	—	ns	$V_{GS} = -10\text{V}$
Turn-off delay time	$t_{d(off)}$	—	35	—	ns	
Fall time	t_f	—	30	—	ns	
Body to drain diode forward voltage	V_{DF}	—	-0.95	—	V	$I_F = -2\text{A}$, $V_{GS} = 0$
Body to drain diode reverse recovery time	t_{rr}	—	60	—	ns	$I_F = -2\text{A}$, $V_{GS} = 0$ $diF/dt = 50\text{A}/\mu\text{s}$

Notes: 1. Pulse test
2. Marking is "WY".

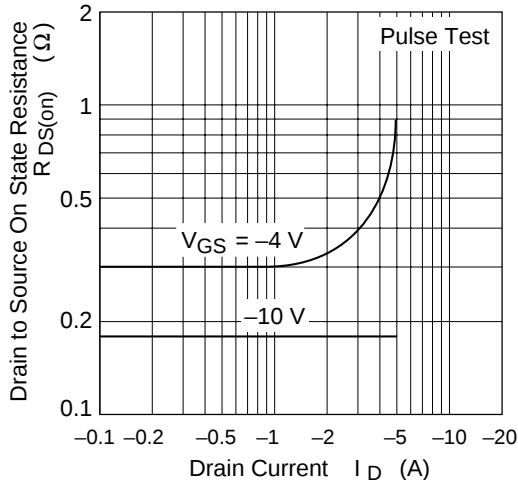
Main Characteristics



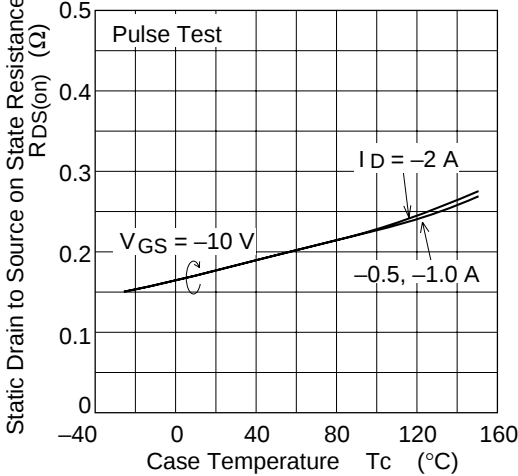
Drain to Source Saturation Voltage vs.
Gate to Source Voltage



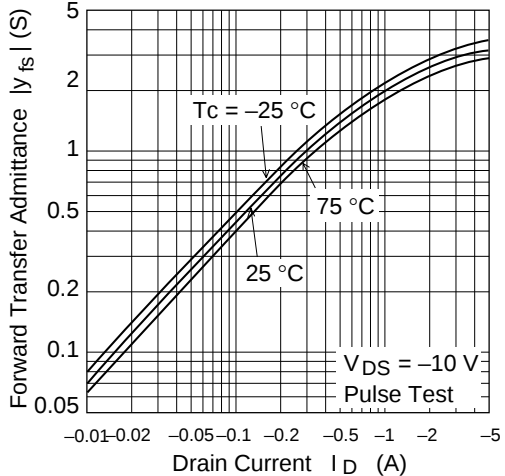
Static Drain to Source on State Resistance
vs. Drain Current



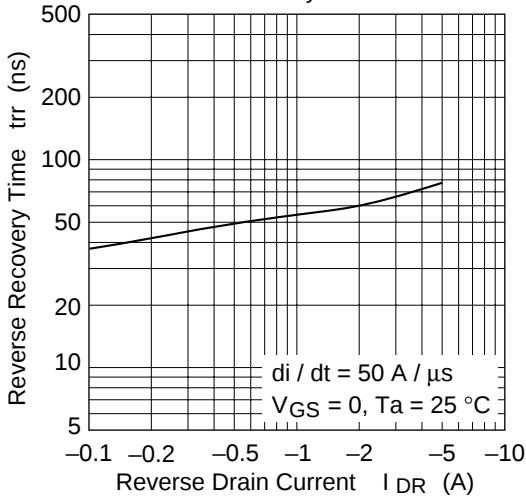
Static Drain to Source on State Resistance
vs. Temperature



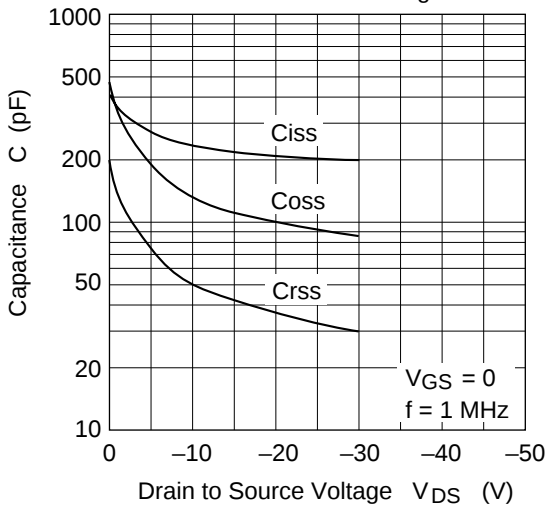
Forward Transfer Admittance vs.
Drain Current



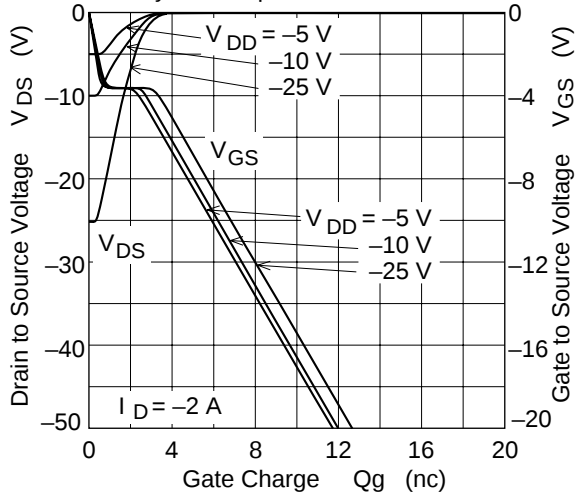
Body to Drain Diode Reverse Recovery Time



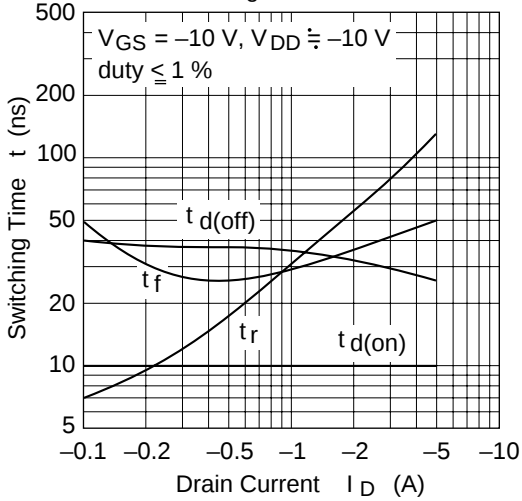
Typical Capacitance vs. Drain to Source Voltage

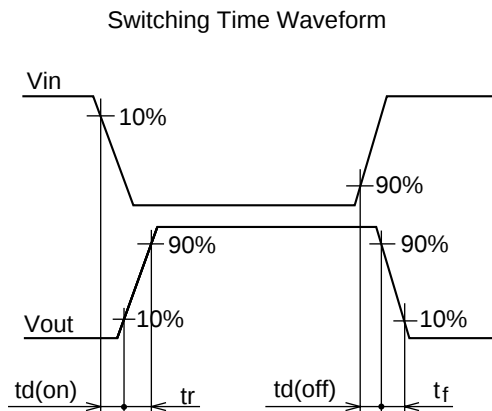
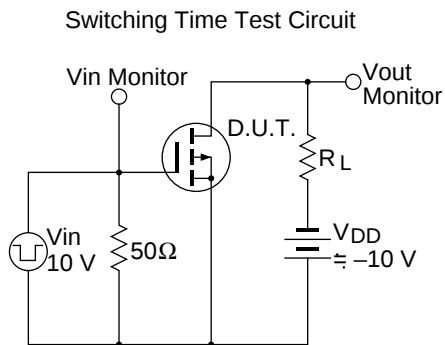
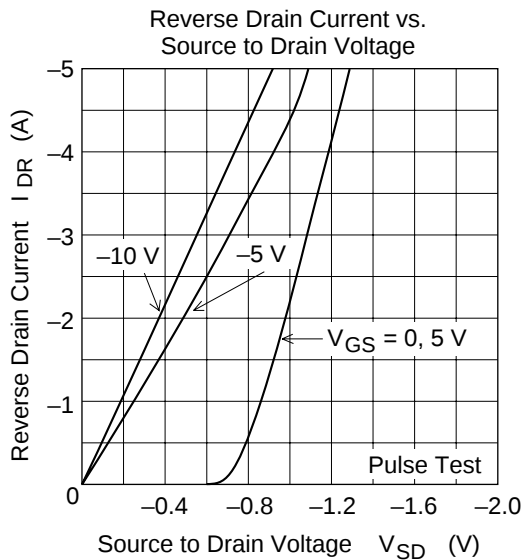


Dynamic Input Characteristics



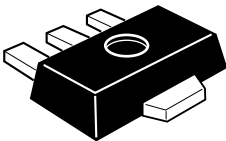
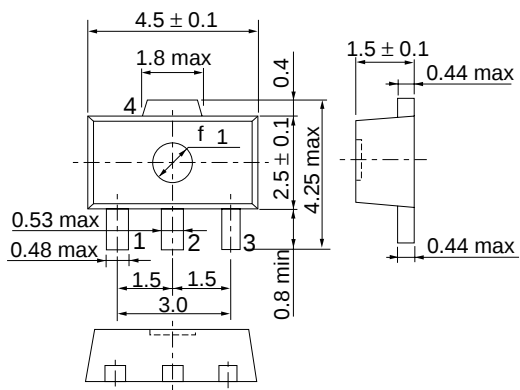
Switching Characteristics





Package Dimensions

Unit: mm



Hitachi Code	UPAK
EIAJ	SC-62
JEDEC	UPAK

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